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Vishay Semiconductors

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST COND	ITIONS	VALUES	UNITS		
		20 A	T.I = 25 °C	0.57			
Maximum forward voltage drop	V _{FM} ⁽¹⁾	40 A	1j=25 C	0.73	v		
See fig. 1	VFM ()	20 A	Т., = 125 °С	0.51			
		40 A	1j = 125 0	0.67			
Maximum reverse leakage current	I _{BM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	2.7	mA		
See fig. 2	'RM \''	T _J = 125 °C	VR - naleu VR	105	IIIA		
Maximum junction capacitance	CT	$V_R = 5 V_{DC}$ (test signal range	100 kHz to 1 MHz), 25 °C	1400	pF		
Typical series inductance	L _S	Measured lead to lead 5 mm	from package body	8.0	nH		
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs		

Note

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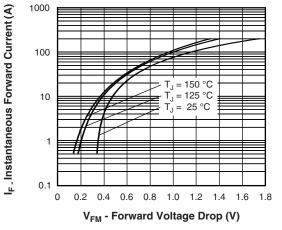
 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range)	T _J , T _{Stg}		-55 to +150	°C	
Maximum thermal resistance, junction to case		R _{thJC}	DC operation See fig. 4	1.50	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50		
Approximate weight				2	g	
Approximate weight				0.07	oz.	
Mounting torque	minimum			6 (5)	kgf ⋅ cm	
Mounting torque	maximum			12 (10)	(lbf · in)	
Marking device			Case style TO-263AB (D ² PAK)	20TQ	045S	

VS-20TQ035SPbF, VS-20TQ040SPbF, VS-20TQ045SPbF

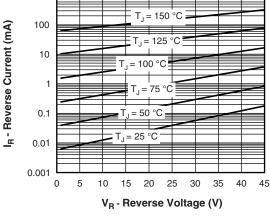
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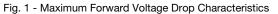


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

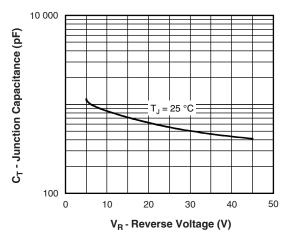


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

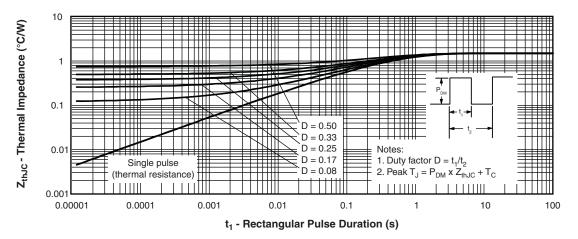


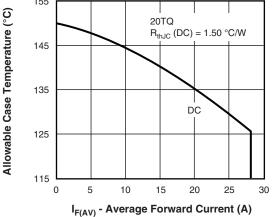
Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

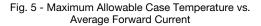
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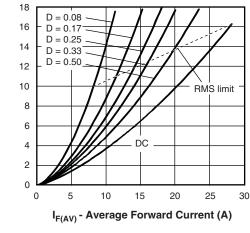
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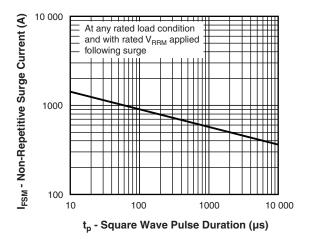
Average Power Loss (W)













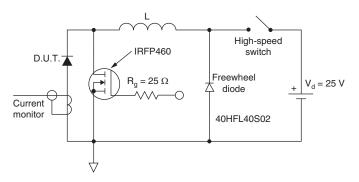


Fig. 8 - Unclamped Inductive Test Circuit

VS-20TQ035SPbF, VS-20TQ040SPbF, VS-20TQ045SPbF



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ORDERING INFORMATION TABLE

Device code	VS-	20	т	Q	045	S	TRL	PbF
		2	3	4	5	6	7	8
	1 - 2 - 3 - 4 - 5 - 6 -	Cur Pac Sch	nay Serr rent ratii kage: T iottky "Q tage rati D ² PAK	ng (20 A = TO-22 " series	.) 20	035 = 3 040 = 4 045 = 4	10 V	
	7 -	• TI • TI	one = tu RL = tap RR = tap ⁻ = lead	be and re	eel (left eel (righ		,	

ORDERING INFORMAT	ION (Example)		
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-20TQ035SPBF	50	1000	Antistatic plastic tubes
VS-20TQ035STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ035STRLPBF	800	800	13" diameter plastic tape and reel
VS-20TQ035-1PBF	50	1000	Antistatic plastic tubes
VS-20TQ040SPBF	50	1000	Antistatic plastic tubes
VS-20TQ040STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ040STRLPBF	800	800	13" diameter plastic tape and reel
VS-20TQ040-1PBF	50	1000	Antistatic plastic tubes
VS-20TQ045SPBF	50	1000	Antistatic plastic tubes
VS-20TQ045STRRPBF	800	800	13" diameter plastic tape and reel
VS-20TQ045STRLPBF	800	800	13" diameter plastic tape and reel
VS-20TQ045-1PBF	50	1000	Antistatic plastic tubes

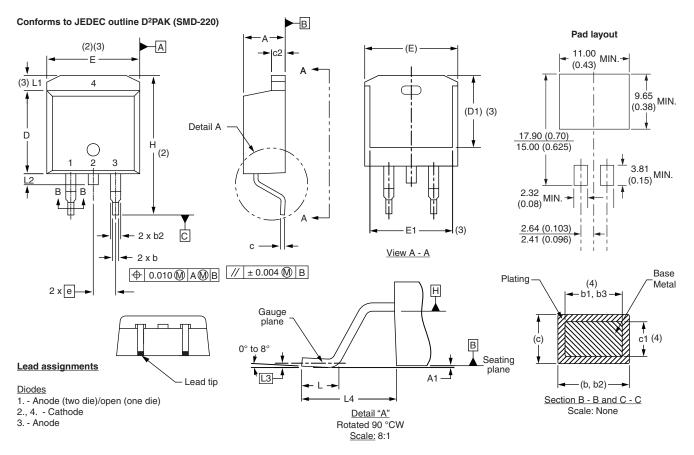
LINKS TO RELATED DOCUMENTS					
Dimonsions	TO-263AB (D ² PAK)	www.vishay.com/doc?95046			
Dimensions	TO-262AA	www.vishay.com/doc?95014			
Part marking information		www.vishay.com/doc?95008			
Packaging information		www.vishay.com/doc?95032			

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D²PAK, TO-262



DIMENSIONS - D²PAK in millimeters and inches

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SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STNIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
с	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100	BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

INCHES

MILLIMETERS

⁽⁷⁾ Outline conforms to JEDEC outline TO-263AB

Notes

 $^{(1)}\,$ Dimensioning and tolerancing per ASME Y14.5 M-1994 $\,$

⁽²⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

- $^{(3)}\,$ Thermal pad contour optional within dimension E, L1, D1 and E1
- ⁽⁴⁾ Dimension b1 and c1 apply to base metal only
- ⁽⁵⁾ Datum A and B to be determined at datum plane H
- ⁽⁶⁾ Controlling dimension: inch

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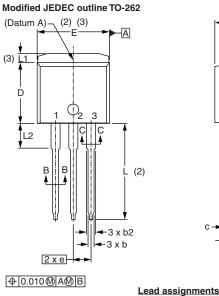
Outline Dimensions

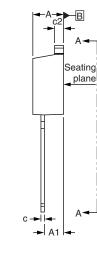
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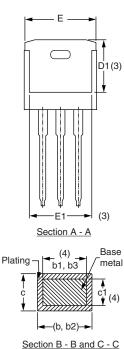
D²PAK, TO-262



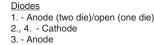
DIMENSIONS - TO-262 in millimeters and inches

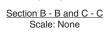






Lead tip





(6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STNIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100	BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

⁽³⁾ Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

⁽⁵⁾ Controlling dimension: inches

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actual package outline

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